Renesas Electronics America Inc - R5F562GAADFH#V1 Datasheet

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, I²C, LINbus, SCI, SPI
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	61
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 5.5V
Data Converters	A/D 12x10b, 8x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	112-LQFP
Supplier Device Package	112-LQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f562gaadfh-v1

Table 1.1 Outline of Specifications (3 / 5)

Classification	Module/Function	Description
Timers	General PWM timer (GPT/GPTa)	• 16 bits x 4 channels • Counting up or down (saw-wave), counting up and down (triangle-wave) selectable for all channels • Clock sources independently selectable for all channels • 2 input/output pins per channel • 2 output compare/input capture registers per channel • For the 2 output compare/input capture registers of each channel, 4 registers are provided as buffer registers and are capable of operating as comparison registers when buffering is not in use. • In output compare operation, buffer switching can be at peaks or troughs, enabling the generation of laterally asymmetrically PWM waveforms. • Registers for setting up frame intervals on each channel (with capability for generating interrupts on overflow or underflow) • Synchronizable operation of the several counters • Modes of synchronized operation (synchronized, or displaced by desired times for phase shifting) • Generation of dead times in PWM operation • Through combination of three counters, generation of automatic three-phase PWM waveforms incorporating dead times • Starting, clearing, and stopping counters in response to external or internal triggers • Internal trigger sources: output of the internal comparator detection, software, and compare-match • The frequency-divided system clock (ICLK) can be used as a counter clock for measuring timing of the edges of signals produced by frequency-dividing the low-speed on-chip oscillator clock signal dedicated to IWDT (to detect abnormal oscillation). • PWM delay generation can control the timing with which signals on the two PWM output pins for each channel rise and fall with an accuracy of up to 1/32 times the period of the system clock (ICLK) (only for GPTa).
	Compare match timer (CMT)	• (16 bits x 2 channels) x 2 units • Select from among four internal clock signals (PCLK/8, PCLK/32, PCLK/128, PCLK/512)
	Watchdog timer (WDT)	• 8 bits x 1 channel • Select from among eight counter-input clock signals (PCLK/4, PCLK/64, PCLK/128, PCLK/512, PCLK/2048, PCLK/8192, PCLK/32768, PCLK/131072) • Switchable between watchdog timer mode and interval timer mode
	Independent watchdog timer (IWDT)	• 14 bits x 1 channel • Counter-input clock: low-speed on-chip oscillator dedicated to IWDT
Communications	Serial communications interface (SCIb)	• 3 channels • Serial communications modes: Asynchronous, clock synchronous, and smart-card interface • Multiprocessor communications • On-chip baud rate generator allows selection of the desired bit rate • Choice of LSB-first or MSB-first transfer • Noise cancellation (only available in asynchronous mode)
	I^2C bus interface (RIIC)	• 1 channel • Communications formats I^2C bus format/SMBus format Master/slave selectable

Table 1.1 Outline of Specifications (4 / 5)

Classification	Module/Function	Description
Communications	CAN module (CAN) (as an optional function)	• 1 channel • 32 mailboxes
	Serial peripheral interface (RSPI)	• 1 unit • RSPI transfer facility Using the MOSI (master out, slave in), MISO (master in, slave out), SSL (slave select), and RSPI clock (RSPCK) signals enables serial transfer through SPI operation (four lines) or clock-synchronous operation (three lines) Capable of handling serial transfer as a master or slave • Data formats Switching between MSB first and LSB first The number of bits in each transfer can be changed to any number of bits from 8 to 16, or to 20, 24, or 32 bits. 128-bit buffers for transmission and reception Up to four frames can be transmitted or received in a single transfer operation (with each frame having up to 32 bits) • Buffered structure • Double buffers for both transmission and reception
	LIN module (LIN)	• 1 channel (LIN master) • Supports revisions 1.3, 2.0, and 2.1 of the LIN protocol
A/D converter	12-bit A/D converter (S12ADA)	• 12 bits (2 units x 4 channels) • 12-bit resolution • Conversion time: 1.0 μs per channel (in operation with A/D conversion clock ADCLK at 50 MHz) for AVCC = 4.0 to 5.5 V 2.0 μs per channel (in operation with A/D conversion clock ADCLK at 25 MHz) for AVCC0 = 3.0 to 3.6 V • Two basic operating modes Single mode and scan mode • Scan mode One-cycle scan mode Continuous scan mode 2-channel scan mode (Input ports of the A/D unit are divided into two groups in this mode, and the activation sources are separately selectable for each group.) • Sample-and-hold function A common sample-and-hold circuit for both units is included. Additionally, sample-and-hold circuit for each unit is included. (three channels per unit) • A/D-conversion register settings for each input pin. • Two registers for the result of conversion are provided for a single analog input pin of each unit (AN000 and AN100). • Three ways to start A/D conversion Conversion can be started by software, a conversion start trigger from a timer (MTU3 or GPT), or an external trigger signal. • Functionality for 8- or 10-bit precision output Right-shifting of the results of conversion for output by two or four bits is selectable. • Self-diagnostic function The self-diagnostic function internally generates three analog input voltages (VREFL0, VREFH0 x 1/2, VREFH0). • Amplification of input signals by a programmable gain amplifier (three channels per unit) Amplification rate: 2.0-, 2.5-, 3.077-, 3.636-, 4.0-, 4.444-, 5.0-, 5.714-, 6.667-, 10.0-, or 13.333-times amplification (a total of 11 steps) • Window comparators (three channels per unit)

Table 1.1 Outline of Specifications (5 / 5)

Classification	Module/Function	Description
A/D converter	10-bit A/D converter (ADA)	• 10 bits (1 unit x 12 channels) • 10-bit resolution • Conversion time: 1.0 μs per channel (in operation with A/D conversion clock ADCLK at 50 MHz) for AVCC0 = 4.0 to 5.5 V 2.0 μs per channel (in operation with A/D conversion clock ADCLK at 25 MHz) for AVCC = 3.0 to 3.6 V • Two basic operating modes Single mode and scan mode • Scan mode One-cycle scan mode Continuous scan mode • Sample-and-hold function A common sample-and-hold circuit for both units is included. • A/D-conversion register settings for each input pin • Three ways to start A/D conversion Conversion can be started by software, a conversion start trigger from a timer (MTU3 or GPT), or an external trigger signal. • Functionality for 8-bit precision output Right-shifting the results of conversion for output by two bits is selectable. • Self-diagnostic function The self-diagnostic function internally generates three analog input voltages (AVSS, VREF x 1/2, VREF).
CRC calculator (CRC)		• CRC code generation for arbitrary amounts of data in 8-bit units • Select any of three generating polynomials: $X^8 + X^2 + X + 1$, $X^{16} + X^{15} + X^2 + 1$, or $X^{16} + X^{12} + X^5 + 1$. • Generation of CRC codes for use with LSB-first or MSB-first communications is selectable.
Operating frequency		ICLK: 8 to 100 MHz PCLK: 8 to 50 MHz
Power supply voltage		• 3-V version VCC = PLLVCC = 2.7 to 3.6V AVCC0 = AVCC = 3.0 to 3.6V, or 4.0 to 5.5V VREFH0 = 3.0 to AVCC0, or 4.0 to AVCC0 VREF = 3.0 to AVCC, or 4.0 to AVCC • 5-V version VCC = PLLVCC = 4.0 to 5.5V AVCC0 = AVCC = 4.0 to 5.5V VREFH0 = 4.0 to AVCC0 VREF = 4.0 to AVCC
Operating temperature		D version: -40 to +85°C, G version: -40 to +105°C*1
Packages		112-pin LQFP (PLQP0112JA-A, 20x20-0.65-mm pitch) 100-pin LQFP (PLQP0100KB-A, 14x14-0.5-mm pitch) 80-pin LQFP (PLQP0080JA-A, 14x14-0.65-mm pitch) 64-pin LQFP (PLQP0064KB-A, 10x10-0.5-mm pitch) 64-pin LQFP (PLQP0064GA-A, 14x14-0.8mm pitch)

Note 1. Please contact Renesas Electronics sales office for derating of operation under Ta = +85°C to +105°C. Derating is the systematic reduction of load for the sake of improved reliability.

Table 1.2 Functions of RX62T Group and RX62G Group Products (1 / 2)

Functions		RX62G Group		RX62T Group				
Pin number		112 Pins	100 Pins	112 Pins	100 Pins	80 Pins (R5F562TxGDFF)	80 Pins	64 Pins
Data transfer	Data transfer controller (DTC)	√						
Interrupt controller (ICU)	Input on the NMI pin	√						
	Input on the IRQ pins	√ (8)						√ (4)
Timers	Multi-function timer pulse unit 3 (MTU3)	√				√*1		
	General PWM timer (GPT)	—		√		√*1		
	General PWM timer (GPTa)	√		—				
	MTU3/GPT complementary PWM pin	12					6	
	Port output enable 3 (POE3)	√ (POE pins: 5)						√ (POE pins: 3)
	Compare match timer (CMT)	√						
	Watchdog timer (WDT)	√						
	Independent watchdog timer (IWDT)	√						
Communication function	Serial communications interface (SCI)	√						
	I²C bus interface (RIIC)	√						
	CAN module (CAN) (as an optional function)	√						
	LIN module (LIN)	√						
	Serial peripheral interface (RSPI)	√						
12-bit A/D converter (S12ADA)		√ (4 ch. x 2 units)						
	Simultaneous sampling on three channels	√ (2 units)						
	Programmable gain amplifier	√ (3 ch. x 2 units)						
	Window comparator	√ (3 ch. x 2 units)						
10-bit A/D converter (ADA)		√ (12 ch.)				√ (4 ch.)		—
CRC calculator (CRC)		√						
I/O ports	I/O pins	61	55	61	55	44	44	37
	Input pins	21	21	21	21	13	13	9

Table 1.4 List of Pins and Pin Functions (112-Pin LQFP) (2 / 3)

Pin No. (112-Pin LQFP)	Power Supply Clock System Control	I/O Port	Analog	Timer	Communi-cation	Interrupt	POE	Debugging
44		PA0		MTIOC6C	SSL3-B			
45	VCC							
46		P96				IRQ4	POE4#	
47	VSS							
48		P95		MTIOC6B				
49		P94		MTIOC7A				
50		P93		MTIOC7B				
51		P92		MTIOC6D				
52		P91		MTIOC7C				
53		P90		MTIOC7D				
54		PG5						TRCLK
55		PG4						TRDATA3
56		PG3						TRDATA2
57		PG2				IRQ2-B		TRDATA1
58		PG1				IRQ1-C		TRDATA0
59		PG0				IRQ0-C		TRSYNC
60		P76		MTIOC4D/ GTIOC2B-A				
61		P75		MTIOC4C/ GTIOC1B-A				
62		P74		MTIOC3D/ GTIOC0B-A				
63		P73		MTIOC4B/ GTIOC2A-A				
64		P72		MTIOC4A/ GTIOC1A-A				
65		P71		MTIOC3B/ GTIOC0A-A				
66		P70				IRQ5	POE0#	
67		P33		MTIOC3A/ MTCLKA-A	SSL3-A			
68		P32		MTIOC3C/ MTCLKB-A	SSL2-A			
69	VCC							
70		P31		MTIOC0A-B/ MTCLKC-A	SSL1-A			
71	VSS							
72		P30		MTIOC0B-B/ MTCLKD-A	SSL0-A			
73		P24			RSPCK-A			
74		P23			CTX-B/ LTX/ MOSI-A			
75		P22	ADTRG#		CRX-B/ LRX/ MISO-A			
76		P21	ADTRG1#-B	MTCLKA-B		IRQ6		
77		P20	ADTRG0#-B	MTCLKB-B		IRQ7		
78		P65	AN5					
79		P64	AN4					

Table 1.5 List of Pins and Pin Functions (100-Pin LQFP) (1 / 3)

Pin No. (80-Pin LQFP)	Power Supply Clock System Control	I/O Port	Analog	Timer	Communi-cation	Interrupt	POE	Debugging
1		PE5				IRQ0-B		
2	EMLE							
3	VSS							
4	MDE							
5	VCL							
6	MD1							
7	MD0							
8		PE4		MTCLKC-C		IRQ1-B	POE10#-B	
9		PE3		MTCLKD-C		IRQ2-A	POE11#	
10	RES#							
11	XTAL							
12	VSS							
13	EXTAL							
14	VCC							
15		PE2				NMI	POE10#-A	
16		PE1			SSL3-C			
17		PE0			CRX-C/ SSL2-C			
18		PD7		GTIOC0A-B	CTX-C/ SSL1-C			TRST#
19		PD6		GTIOC0B-B	SSL0-C			TMS
20		PD5		GTIOC1A-B	RXD1			TDI
21		PD4		GTIOC1B-B	SCK1			TCK
22		PD3		GTIOC2A-B	TXD1			TDO
23		PD2		GTIOC2B-B	MOSI-C			TRCLK
24		PD1		GTIOC3A	MISO-C			TRDATA3
25		PD0		GTIOC3B	RSPCK-C			TRDATA2
26		PB7			SCK2-A			TRDATA1
27		PB6			CRX-A/ RXD2-A			TRDATA0
28		PB5			CTX-A/ TXD2-A			TRSYNC
29	PLLVCC							
30		PB4		GTETRG		IRQ3	POE8#	
31	PLLVSS							
32		PB3		MTIOC0A-A	SCK0			
33		PB2		MTIOC0B-A	TXD0/SDA			
34		PB1		MTIOC0C	RXD0/SCL			
35		PB0		MTIOC0D	MOSI-B			
36		PA5	ADTRG1#-A	MTIOC1A	MISO-B			
37		PA4	ADTRG0#-A	MTIOC1B	RSPCK-B			
38		PA3		MTIOC2A	SSL0-B			
39		PA2		MTIOC2B	SSL1-B			
40		PA1		MTIOC6A	SSL2-B			

Table 1.7 List of Pins and Pin Functions (80-Pin LQFP: R5F562TxGDFF) (3 / 3)

Pin No. (80-Pin LQFP)	Power Supply Clock System Control	I/O Port	Analog	Timer	Communication	Interrupt	POE	Debugging
76	AVSS0							
77		P82		MTIC5U	SCK2-B			
78		P81		MTIC5V	TXD2-B			
79		P80		MTIC5W	RXD2-B			
80		P10		MTCLKD-B		IRQ0-A		

Table 1.9 Pin Functions (3 / 4)

Classifications	Pin Name	I/O	Description
Serial communications interface (SCIb)	TXD0, TXD1, TXD2-A/TXD2-B	Output	Output pins for data transmission. The TXD2-B pin is not included in the 80-/64-pin versions.
	RXD0, RXD1, RXD2-A/ RXD2-B	Input	Input pins for data reception. The RXD2-B pin is not included in the 80-/64-pin versions.
	SCK0, SCK1, SCK2-A/ SCK2-B	I/O	Input/output pins for clock signals. The SCK2-B pin is not included in the 80-/64-pin versions.
I^2C bus interface (RIIC)	SCL	I/O	Input/output pin for I^2C bus interface clocks. Bus can be directly driven by the NMOS open drain output.
	SDA	I/O	Input/output pin for I^2C bus interface data. Bus can be directly driven by the NMOS open drain output.
CAN module (CAN) (as an optional function)	CRX-A/CRX-B/CRX-C	Input	Input pin for the CAN. The CRX-C pin is not included in the 64-pin version.
	CTX-A/CTX-B/CTX-C	Output	Output pin for the CAN. The CTX-C pin is not included in the 64-pin version.
LIN module (LIN)	LRX	Input	Input pin for the LIN.
	LTX	Output	Output pin for the LIN.
Serial peripheral interface (RSPI)	RSPCK-A/RSPCK-B/ RSPCK-C	I/O	Clock input/output pin for the RSPI. The RSPCK-C pin is not included in the 80-/64-pin versions.
	MOSI-A/MOSI-B/MOSI-C	I/O	Inputs or outputs data output from the master for the RSPI. The MOSI-C pin is not included in the 80-/64-pin versions.
	MISO-A/MISO-B/MISO-C	I/O	Inputs or outputs data output from the slave for the RSPI. The MISO-C pin is not included in the 80-/64-pin versions.
	SSL0-A/SSL0-B/SSL0-C	I/O	Select the slave for the RSPI. The SSL0-C/SSL1-C/SSL2-C/ SSL3-C pin is not included in the 80-/64-pin versions.
	SSL1-A/SSL1-B/SSL1-C SSL2-A/SSL2-B/SSL2-C SSL3-A/SSL3-B/SSL3-C	Output	
A/D converter	AN000 to AN003 AN100 to AN103	Input	Input pins for the analog signals to be processed by the 12-bit A/D converter.
	AN0 to AN11	Input	Input pins for the analog signals to be processed by the 10-bit A/D converter. The AN4 to AN11 pins are not included in the 80-pin version. Not included in the 64-pin version.
	ADTRG0#-A/ADTRG0#-B ADTRG1#-A/ADTRG1#-B ADTRG#	Input	Input pins for the external trigger signals that start the A/D conversion. The ADTRG0#-B/ADTRG1#-B/ADTRG# pin is not included in the 64-pin version.
	CVREFH	Input	Input pin for the high-level reference voltage to the comparator
	CVREFL	Input	Input pin for the low-level reference voltage to the comparator
Analog power supply	AVCC0	Input	Analog power supply pin for the 12-bit A/D converter. When the A/D converter is not in use, connect this pin to the system power supply.
	AVSS0	Input	Ground pin for the 12-bit A/D converter. Connect this pin to the system power supply (0 V).
	VREFH0	Input	Reference power supply pin for the 12-bit A/D converter. When the 12-bit A/D converter is not in use, connect this pin to the system power supply.
	VREFL0	Input	Ground pin of the reference power supply pin for the 12-bit A/D converter. When the 12-bit A/D converter is not in use, connect this pin to the system power supply (0 V).
	AVCC	Input	Analog power supply pin for the 10-bit A/D converter. When the A/D converter is not in use, connect this pin to the system power supply. Not included in the 64-pin version.
	AVSS	Input	Ground pin for the 10-bit A/D converter. Connect this pin to the system power supply (0 V). Not included in the 64-pin version.
	VREF	Input	Reference power supply pin for the 10-bit A/D converter. When the 10-bit A/D converter is not in use, connect this pin to the system power supply. Not included in the 80-/64-pin versions.

4. I/O Registers

This section gives information on the on-chip I/O register addresses and bit configurations. The information is given as shown below. Notes on writing to registers are also given at the end.

(1) I/O register addresses (address order)

- Registers are listed from the lower allocation addresses.
- Registers are classified according to functional modules (abbreviations).
- The number of access cycles indicates the number of states based on the specified reference clock.
- Among the I/O register area, addresses not listed in the list of registers are reserved. Reserved addresses must not be accessed. Do not access these addresses; otherwise, the operation when accessing these bits and subsequent operations cannot be guaranteed.
- A unit of access is specified for each register. Access other than in the specified unit is prohibited.

(2) I/O register bits

- Bit configurations of the registers are listed in the same order as the register addresses.
- Reserved bits are indicated by "—" in the bit name column.
- Space in the bit name field indicates that the entire register is allocated to either the counter or data.
- For the registers of 16 or 32 bits, the MSB is listed first.

(3) Notes on writing to I/O registers

When writing to an I/O register, the CPU starts executing the subsequent instruction before completing I/O register write. This may cause the subsequent instruction to be executed before the post-update I/O register value is reflected on the operation.
As described in the following examples, special care is required for the cases in which the subsequent instruction must be executed after the post-update I/O register value is actually reflected.

[Examples of cases requiring special care]

- The subsequent instruction must be executed while an interrupt request is disabled with the IENj bit in IERm of the ICU (interrupt request enable bit)*1 cleared to 0.
- A WAIT instruction is executed immediately after the preprocessing for causing a transition to the low power consumption state.

Note 1. See section 11.2.2, Interrupt Request Enable Register m (IERm) (m = 02h to 1Fh) in the User's manual: Hardware.

In the above cases, after writing to an I/O register, wait until the write operation is completed using the following procedure and then execute the subsequent instruction.

Table 4.1 List of I/O Registers (Address Order) (24 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
000C 22B6h	GPT3	General PWM timer dead time control register	GTDTCR	16	16, 32	3 to 5 ICLK*4
000C 22B8h	GPT3	General PWM timer dead time value register	GTDVU	16	16, 32	3 to 5 ICLK*4
000C 22BAh	GPT3	General PWM timer dead time value register	GTDVD	16	16, 32	3 to 5 ICLK*4
000C 22BCh	GPT3	General PWM timer dead time buffer register	GTDBU	16	16, 32	3 to 5 ICLK*4
000C 22BEh	GPT3	General PWM timer dead time buffer register	GTDBD	16	16, 32	3 to 5 ICLK*4
000C 22C0h	GPT3	General PWM timer output protection function status register	GTSOS	16	16, 32	3 to 5 ICLK*4
000C 22C2h	GPT3	General PWM timer output protection temporary release register	GTSOTR	16	16, 32	3 to 5 ICLK*4
000C 2300h	GPT0	PWM output delay control register	GTDLYCR	16	16, 32	3 to 5 ICLK*4
000C 2302h	GPT1	PWM output delay control register	GTDLYCR	16	16, 32	3 to 5 ICLK*4
000C 2304h	GPT2	PWM output delay control register	GTDLYCR	16	16, 32	3 to 5 ICLK*4
000C 2306h	GPT3	PWM output delay control register	GTDLYCR	16	16, 32	3 to 5 ICLK*4
000C 2318h	GPT0	GTIOCA rising output delay register	GTDLYRA	16	16, 32	3 to 5 ICLK*4
000C 231Ah	GPT0	GTIOCB rising output delay register	GTDLYRB	16	16, 32	3 to 5 ICLK*4
000C 231Ch	GPT1	GTIOCA rising output delay register	GTDLYRA	16	16, 32	3 to 5 ICLK*4
000C 231Eh	GPT1	GTIOCB rising output delay register	GTDLYRB	16	16, 32	3 to 5 ICLK*4
000C 2320h	GPT2	GTIOCA rising output delay register	GTDLYRA	16	16, 32	3 to 5 ICLK*4
000C 2322h	GPT2	GTIOCB rising output delay register	GTDLYRB	16	16, 32	3 to 5 ICLK*4
000C 2324h	GPT3	GTIOCA falling output delay register	GTDLYRA	16	16, 32	3 to 5 ICLK*4
000C 2326h	GPT3	GTIOCB falling output delay register	GTDLYRB	16	16, 32	3 to 5 ICLK*4
000C 2328h	GPT0	GTIOCA falling output delay register	GTDLYFA	16	16, 32	3 to 5 ICLK*4
000C 232Ah	GPT0	GTIOCB falling output delay register	GTDLYFB	16	16, 32	3 to 5 ICLK*4
000C 232Ch	GPT1	GTIOCA falling output delay register	GTDLYFA	16	16, 32	3 to 5 ICLK*4
000C 232Eh	GPT1	GTIOCB falling output delay register	GTDLYFB	16	16, 32	3 to 5 ICLK*4
000C 2330h	GPT2	GTIOCA falling output delay register	GTDLYFA	16	16, 32	3 to 5 ICLK*4
000C 2332h	GPT2	GTIOCB falling output delay register	GTDLYFB	16	16, 32	3 to 5 ICLK*4
000C 2334h	GPT3	GTIOCA falling output delay register	GTDLYFA	16	16, 32	3 to 5 ICLK*4
000C 2336h	GPT3	GTIOCB falling output delay register	GTDLYFB	16	16, 32	3 to 5 ICLK*4
007F C402h	FLASH	Flash mode register	FMODR	8	8	2, 3 PCLK*3
007F C410h	FLASH	Flash access status register	FASTAT	8	8	2, 3 PCLK*3
007F C411h	FLASH	Flash access error interrupt enable register	FAEINT	8	8	2, 3 PCLK*3
007F C412h	FLASH	Flash ready interrupt enable register	FRDYIE	8	8	2, 3 PCLK*3
007F C440h	FLASH	Data flash read enable register 0	DFLRE0	16	16	2, 3 PCLK*3
007F C442h	FLASH	Data flash read enable register 1	DFLRE1	16	16	2, 3 PCLK*3
007F C450h	FLASH	Data flash programming/erasure enable register 0	DFLWE0	16	16	2, 3 PCLK*3
007F C452h	FLASH	Data flash programming/erasure enable register 1	DFLWE1	16	16	2, 3 PCLK*3
007F C454h	FLASH	FCU RAM enable register	FCURAME	16	16	2, 3 PCLK*3
007F FFB0h	FLASH	Flash status register 0	FSTATR0	8	8	2, 3 PCLK*3
007F FFB1h	FLASH	Flash status register 1	FSTATR1	8	8	2, 3 PCLK*3
007F FFB2h	FLASH	Flash P/E mode entry register	FENTRYR	16	16	2, 3 PCLK*3
007F FFB4h	FLASH	Flash protect register	FPROTR	16	16	2, 3 PCLK*3
007F FFB6h	FLASH	Flash reset register	FRESETR	16	16	2, 3 PCLK*3

Table 4.2 List of I/O Registers (Bit Order) (7 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
ICU	DTCER180	—	—	—	—	—	—	—	DTCE
ICU	DTCER181	—	—	—	—	—	—	—	DTCE
ICU	DTCER182	—	—	—	—	—	—	—	DTCE
ICU	DTCER183	—	—	—	—	—	—	—	DTCE
ICU	DTCER184	—	—	—	—	—	—	—	DTCE
ICU	DTCER186	—	—	—	—	—	—	—	DTCE
ICU	DTCER187	—	—	—	—	—	—	—	DTCE
ICU	DTCER188	—	—	—	—	—	—	—	DTCE
ICU	DTCER189	—	—	—	—	—	—	—	DTCE
ICU	DTCER190	—	—	—	—	—	—	—	DTCE
ICU	DTCER192	—	—	—	—	—	—	—	DTCE
ICU	DTCER193	—	—	—	—	—	—	—	DTCE
ICU	DTCER194	—	—	—	—	—	—	—	DTCE
ICU	DTCER195	—	—	—	—	—	—	—	DTCE
ICU	DTCER196	—	—	—	—	—	—	—	DTCE
ICU	DTCER215	—	—	—	—	—	—	—	DTCE
ICU	DTCER216	—	—	—	—	—	—	—	DTCE
ICU	DTCER219	—	—	—	—	—	—	—	DTCE
ICU	DTCER220	—	—	—	—	—	—	—	DTCE
ICU	DTCER223	—	—	—	—	—	—	—	DTCE
ICU	DTCER224	—	—	—	—	—	—	—	DTCE
ICU	DTCER247	—	—	—	—	—	—	—	DTCE
ICU	DTCER248	—	—	—	—	—	—	—	DTCE
ICU	DTCER254	—	—	—	—	—	—	—	DTCE
ICU	IER02	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER03	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER05	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER07	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER08	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER0C	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER0D	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER0E	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER0F	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER10	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER11	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER12	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER13	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER15	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER16	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER17	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER18	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER1A	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER1B	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER1C	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER1E	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER1F	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	SWINTR	—	—	—	—	—	—	—	SWINT
ICU	FIR	FIEN	—	—	—	—	—	—	—
		FVCT[7:0]							
ICU	IPR00	—	—	—	—	IPR[3:0]			
ICU	IPR01	—	—	—	—	IPR[3:0]			
ICU	IPR02	—	—	—	—	IPR[3:0]			

Table 4.2 List of I/O Registers (Bit Order) (14 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
PORT8	DR	—	—	—	—	—	B2	B1	B0
PORT9	DR	—	B6	B5	B4	B3	B2	B1	B0
PORTA	DR	—	—	B5	B4	B3	B2	B1	B0
PORTB	DR	B7	B6	B5	B4	B3	B2	B1	B0
PORTD	DR	B7	B6	B5	B4	B3	B2	B1	B0
PORTE	DR	—	—	B5	B4	B3	—	B1	B0
PORTG	DR	—	—	B5	B4	B3	B2	B1	B0
PORT1	PORT	—	—	—	—	—	—	B1	B0
PORT2	PORT	—	—	—	B4	B3	B2	B1	B0
PORT3	PORT	—	—	—	—	B3	B2	B1	B0
PORT4	PORT	B7	B6	B5	B4	B3	B2	B1	B0
PORT5	PORT	—	—	B5	B4	B3	B2	B1	B0
PORT6	PORT	—	—	B5	B4	B3	B2	B1	B0
PORT7	PORT	—	B6	B5	B4	B3	B2	B1	B0
PORT8	PORT	—	—	—	—	—	B2	B1	B0
PORT9	PORT	—	B6	B5	B4	B3	B2	B1	B0
PORTA	PORT	—	—	B5	B4	B3	B2	B1	B0
PORTB	PORT	B7	B6	B5	B4	B3	B2	B1	B0
PORTD	PORT	B7	B6	B5	B4	B3	B2	B1	B0
PORTE	PORT	—	—	B5	B4	B3	B2	B1	B0
PORTG	PORT	—	—	B5	B4	B3	B2	B1	B0
PORT1	ICR	—	—	—	—	—	—	B1	B0
PORT2	ICR	—	—	—	B4	B3	B2	B1	B0
PORT3	ICR	—	—	—	—	B3	B2	B1	B0
PORT4	ICR	B7	B6	B5	B4	B3	B2	B1	B0
PORT5	ICR	—	—	B5	B4	B3	B2	B1	B0
PORT6	ICR	—	—	B5	B4	B3	B2	B1	B0
PORT7	ICR	—	B6	B5	B4	B3	B2	B1	B0
PORT8	ICR	—	—	—	—	—	B2	B1	B0
PORT9	ICR	—	B6	B5	B4	B3	B2	B1	B0
PORTA	ICR	—	—	B5	B4	B3	B2	B1	B0
PORTB	ICR	B7	B6	B5	B4	B3	B2	B1	B0
PORTD	ICR	B7	B6	B5	B4	B3	B2	B1	B0
PORTE	ICR	—	—	B5	B4	B3	—	B1	B0
PORTG	ICR	—	—	B5	B4	B3	B2	B1	B0
IOPORT	PF8IRQ	—	—	—	—	ITS1[1:0]		ITS0[1:0]	
IOPORT	PF9IRQ	—	—	—	—	—	ITS2	—	—
IOPORT	PFAADC	—	—	—	—	—	—	ADTRG1S	ADTRG0S
IOPORT	PFCMTU	TCLKS[1:0]		—	—	—	—	MTUS1	MTUS0
IOPORT	PFDGPT	—	—	—	—	—	—	—	GPTS
IOPORT	PFFSCI	—	—	—	—	—	SCI2S	—	—
IOPORT	PFGSPI	SSL3E	SSL2E	SSL1E	SSL0E	MISOE	MOSIE	RSPCKE	—
IOPORT	PFHSPI	—	—	—	—	—	—	RSPIS[1:0]	
IOPORT	PFJCAN	CANS[1:0]		—	—	—	—	—	CANE
IOPORT	PFKLIN	—	—	—	—	—	—	—	LINE
IOPORT	PFMPOE	—	—	—	POE11E	POE10E	POE8E	POE4E	POE0E
IOPORT	PFNPOE	POE10S	—	—	—	—	—	—	—
SYSTEM	DPSBYCR	DPSBY	IOKEEP	—	—	—	—	—	—
SYSTEM	DPSWCR	—	—	WTSTS[5:0]					
SYSTEM	DPSIER	DNMIE	—	—	DLVDE	—	—	DIRQ1E	DIRQ0E

Table 4.2 List of I/O Registers (Bit Order) (18 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
CAN0*3	AFSR	—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	—
CAN0*3	TCR	—	—	—	—	—	TSTM[1:0]		TSTE
LIN0	LWBR	—	—	—	—	—	—	—	LWBR0
LIN0	LBRP0								
LIN0	LBRP1								
LIN0	LSTC								LSTM
LIN0	L0MD	—	—	—	—	LCKS[1:0]		—	—
LIN0	L0BRK	—	—	BDT[1:0]			BLT[3:0]		
LIN0	L0SPC	—	—	IBS[1:0]		—		IBSH[2:0]	
LIN0	L0WUP		WUTL[3:0]			—	—	—	—
LIN0	L0IE	—	—	—	—	—	ERRIE	FRCIE	FTCIE
LIN0	L0EDE	—	—	—	—	FERE	FTERE	PBERE	BERE
LIN0	L0C	—	—	—	—	—	—	OM1	OM0
LIN0	L0TC	—	—	—	—	—	—	RTS	FTS
LIN0	L0MST	—	—	—	—	—	—	OMM1	OMM0
LIN0	L0ST	HTRC	D1RC	—	—	ERR	—	FRC	FTC
LIN0	L0EST	—	—	CSER	—	FER	FTER	PBER	BER
LIN0	L0RFC	—	FSM	CSM	RFT		RFDL[3:0]		
LIN0	L0IDB	IDP				ID			
LIN0	L0CBR								
LIN0	L0DB1								
LIN0	L0DB2								
LIN0	L0DB3								
LIN0	L0DB4								
LIN0	L0DB5								
LIN0	L0DB6								
LIN0	L0DB7								
LIN0	L0DB8								
MTU3	TCR		CCLR[2:0]			CKEG[1:0]		TPSC[2:0]	
MTU4	TCR		CCLR[2:0]			CKEG[1:0]		TPSC[2:0]	
MTU3	TMDR1	—	—	BFB	BFA			MD[3:0]	
MTU4	TMDR1	—	—	BFB	BFA			MD[3:0]	
MTU3	TIORH		IOB[3:0]					IOA[3:0]	
MTU3	TIORL		IOD[3:0]					IOC[3:0]	
MTU4	TIORH		IOB[3:0]					IOA[3:0]	
MTU4	TIORL		IOD[3:0]					IOC[3:0]	
MTU3	TIER	TTGE	—	—	TCIEV	TGIED	TGIEC	TGIEB	TGIEA
MTU4	TIER	TTGE	TTGE2	—	TCIEV	TGIED	TGIEC	TGIEB	TGIEA
MTU	TOERA	—	—	OE4D	OE4C	OE3D	OE4B	OE4A	OE3B
MTU	TGCRA	—	BDC	N	P	FB	WF	VF	UF
MTU	TOCR1A	—	PSYE	—	—	TOCL	TOCS	OLSN	OLSP
MTU	TOCR2A	BF[1:0]		OLS3N	OLS3P	OLS2N	OLS2P	OLS1N	OLS1P
MTU3	TCNT								
MTU4	TCNT								
MTU	TCDRA								
MTU	TDDRA								

Table 4.2 List of I/O Registers (Bit Order) (29 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
GPT2	GTDLYCR	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLYEN	DLYRST	DLLEN
GPT3	GTDLYCR	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLYEN	DLYRST	DLLEN
GPT0	GTDLYRA	—	—	—	—	—	—	—	—
		—	—	—			DLY[4:0]		
GPT0	GTDLYRB	—	—	—	—	—	—	—	—
		—	—	—			DLY[4:0]		
GPT1	GTDLYRA	—	—	—	—	—	—	—	—
		—	—	—			DLY[4:0]		
GPT1	GTDLYRB	—	—	—	—	—	—	—	—
		—	—	—			DLY[4:0]		
GPT2	GTDLYRA	—	—	—	—	—	—	—	—
		—	—	—			DLY[4:0]		
GPT2	GTDLYRB	—	—	—	—	—	—	—	—
		—	—	—			DLY[4:0]		
GPT3	GTDLYRA	—	—	—	—	—	—	—	—
		—	—	—			DLY[4:0]		
GPT3	GTDLYRB	—	—	—	—	—	—	—	—
		—	—	—			DLY[4:0]		
GPT0	GTDLYFA	—	—	—	—	—	—	—	—
		—	—	—			DLY[4:0]		
GPT0	GTDLYFB	—	—	—	—	—	—	—	—
		—	—	—			DLY[4:0]		
GPT1	GTDLYFA	—	—	—	—	—	—	—	—
		—	—	—			DLY[4:0]		
GPT1	GTDLYFB	—	—	—	—	—	—	—	—
		—	—	—			DLY[4:0]		
GPT2	GTDLYRA	—	—	—	—	—	—	—	—
		—	—	—			DLY[4:0]		
GPT2	GTDLYFB	—	—	—	—	—	—	—	—
		—	—	—			DLY[4:0]		
GPT3	GTDLYFA	—	—	—	—	—	—	—	—
		—	—	—			DLY[4:0]		
GPT3	GTDLYFB	—	—	—	—	—	—	—	—
		—	—	—			DLY[4:0]		
FLASH	FMODR	—	—	—	FRDMD		—	—	—
FLASH	FASTAT	ROMAE	—	—	CMDLK	DFLAE	—	DFLRPE	DFLWPE
FLASH	FAEINT	ROMAEIE	—	—	CMDLKIE	DFLAEIE	—	DFLRPEIE	DFLWPEIE
FLASH	FRDYIE	—	—	—	—	—	—	—	FRDYIE
FLASH	DFLRE0				KEY[7:0]				
		DBRE07	DBRE06	DBRE05	DBRE04	DBRE03	DBRE02	DBRE01	DBRE00
FLASH	DFLRE1				KEY[7:0]				
		DBRE15	DBRE14	DBRE13	DBRE12	DBRE11	DBRE10	DBRE09	DBRE08
FLASH	DFLWE0				KEY[7:0]				
		DBWE07	DBWE06	DBWE05	DBWE04	DBWE03	DBWE02	DBWE01	DBWE00
FLASH	DFLWE1				KEY[7:0]				
		DBWE15	DBWE14	DBWE13	DBWE12	DBWE11	DBWE10	DBWE09	DBWE08
FLASH	FCURAME				KEY[7:0]				
		—	—	—	—	—	—	—	FCRME

5. Electrical Characteristics

5.1 Absolute Maximum Ratings

Table 5.1 Absolute Maximum Ratings

Item		Symbol	Value	Unit
Power supply voltage		VCC PLLVCC	-0.3 to +6.5	V
Input voltage (except for ports 4 to 6)		V_{IN}	-0.3 to VCC+0.3	V
Input voltage (port 4)		V_{IN}	-0.3 to AVCC0+0.3	V
Input voltage (ports 5 and 6)		V_{IN}	-0.3 to AVCC+0.3	V
Analog power supply voltage		AVCC0, AVCC*1	-0.3 to +6.5	V
Reference power supply voltage		VREFH0*1	-0.3 to AVCC0+0.3	V
		VREF*1	-0.3 to AVCC+0.3	
Analog input voltage (port 4)		V_{AN}	-0.3 to AVCC0+0.3	V
Analog input voltage (ports 5 and 6)		V_{AN}	-0.3 to AVCC+0.3	V
Operating temperature	D version	T_{opr}	-40 to +85	°C
	G version	T_{opr}	-40 to +105	°C
Storage temperature		T_{stg}	-55 to +125	°C

Caution: Permanent damage to the LSI may result if absolute maximum ratings are exceeded.

Note 1. Do not leave the AVCC0, VREFH0, VREFL0, AVSS0, AVCC, VREF, and AVSS pins open circuit even if the A/D converter is not to be used.
- When the 12-bit converter is not in use:
  Connect the AVCC0 pin to AVCC (or VCC for a 64-pin product), the VREFH0 pin to VREF (or AVCC or VCC for an 80- or 64-pin product, respectively), and the AVSS0 and VREFL0 pins to VSS.
- When the 10-bit converter is not in use:
  Connect the AVCC pin to AVCC0, the VREF pin to VREFH0, and the AVSS pin to AVSS0.
- When neither the 10- nor the 12-bit converter is in use:
  Connect the AVCC0, VREFH0, AVCC, and VREF pins to VCC, and the AVSS0, VREFL0, and AVSS pins to VSS.

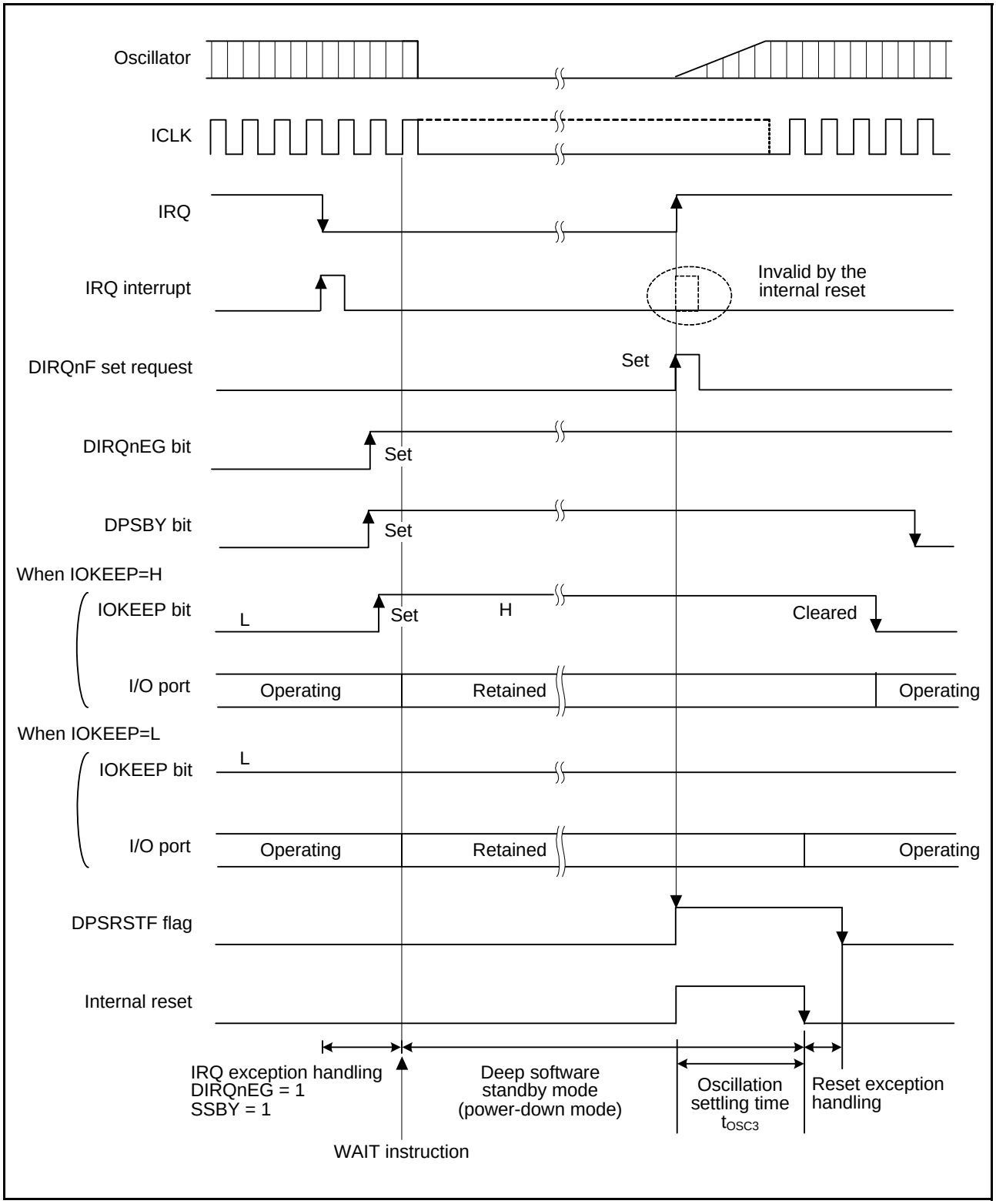


Figure 5.3 Oscillation Settling Timing after Deep Software Standby Mode

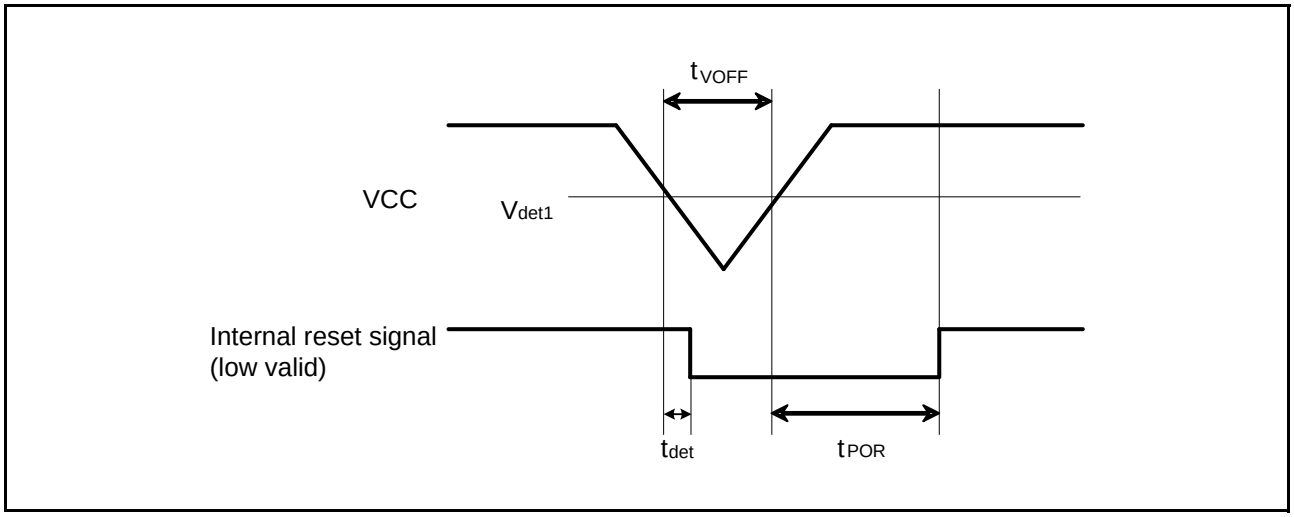


Figure 5.21 Voltage Detection Circuit Timing (Vdet1)

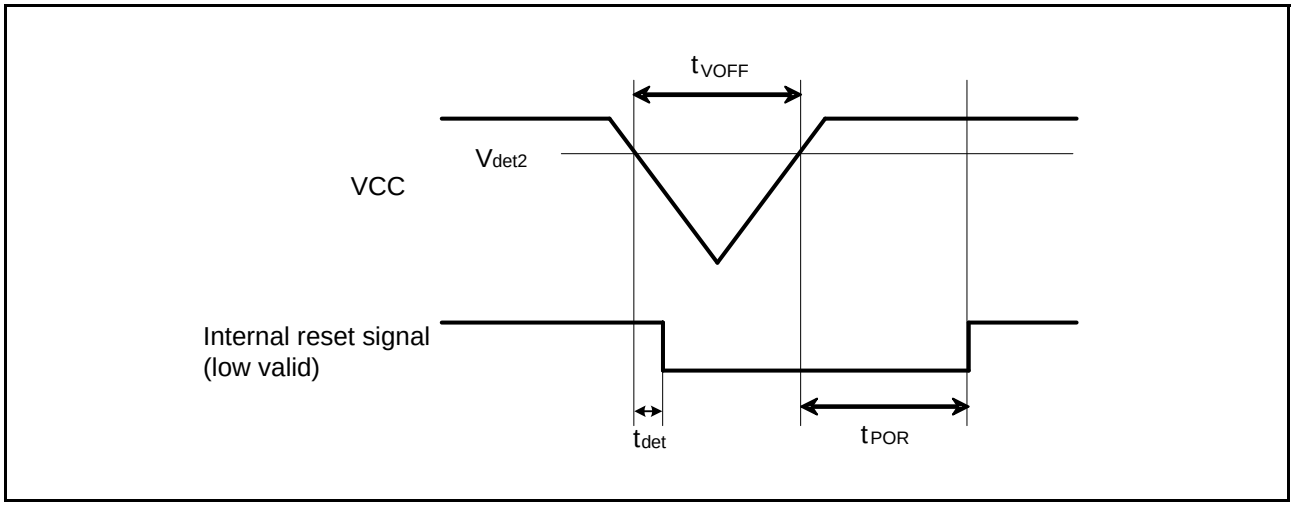
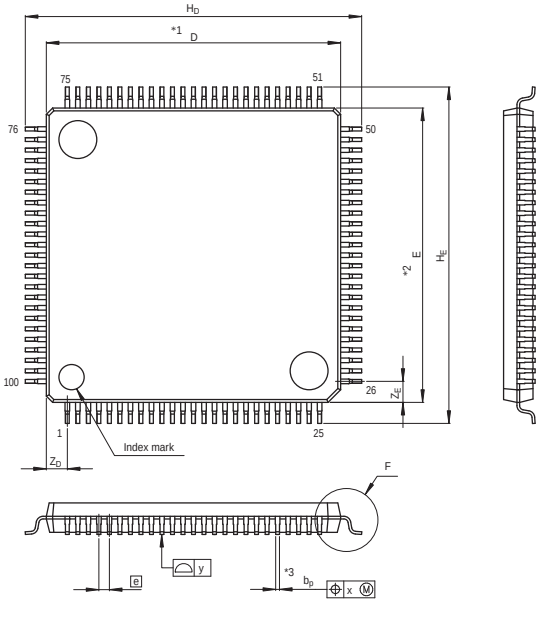
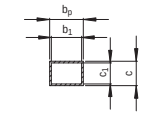
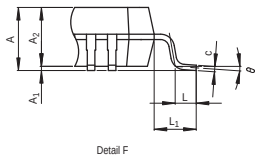


Figure 5.22 Voltage Detection Circuit Timing (Vdet2)

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LQFP100-14x14-0.50	PLQP0100KB-A	100P6Q-A / FP-100U / FP-100UV	0.6g





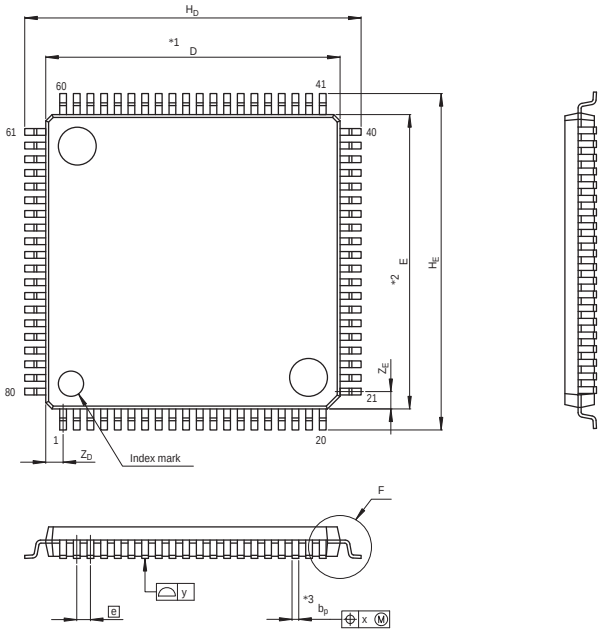


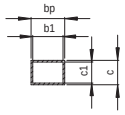
NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	13.9	14.0	14.1
E	13.9	14.0	14.1
A_2	—	1.4	—
H_D	15.8	16.0	16.2
H_E	15.8	16.0	16.2
A	—	—	1.7
A_1	0.05	0.1	0.15
b_p	0.15	0.20	0.25
b_1	—	0.18	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.5	—
x	—	—	0.08
y	—	—	0.08
Z_D	—	1.0	—
Z_E	—	1.0	—
L	0.35	0.5	0.65
L_1	—	1.0	—

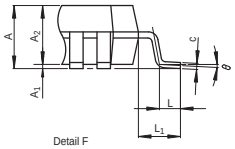
Figure B 100-Pin LQFP (PLQP0100KB-A) Package Dimensions

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LQFP80-14x14-0.65	PLQP0080JA-A	FP-80W / FP-80WV	0.6g





Terminal cross section



Detail F

NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	13.9	14.0	14.1
E	13.9	14.0	14.1
A_2	—	1.4	—
H_D	15.8	16.0	16.2
H_E	15.8	16.0	16.2
A	—	—	1.7
A_1	0.05	0.1	0.15
b_p	0.27	0.32	0.37
b_1	—	0.30	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.65	—
x	—	—	0.13
y	—	—	0.10
Z_D	—	0.825	—
Z_E	—	0.825	—
L	0.35	0.5	0.65
L_1	—	1.0	—

Figure C 80-Pin LQFP (PLQP0080JA-A) Package Dimensions

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Renesas Electronics America Inc.
2880 Scott Boulevard Santa Clara, CA 95050-2554, U.S.A.
Tel: +1-408-588-6000, Fax: +1-408-588-6130

Renesas Electronics Canada Limited
1101 Nicholson Road, Newmarket, Ontario L3Y 9C3, Canada
Tel: +1-905-898-5441, Fax: +1-905-898-3220

Renesas Electronics Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K
Tel: +44-1628-651-700, Fax: +44-1628-651-804

Renesas Electronics Europe GmbH
Arcadiastrasse 10, 40472 Düsseldorf, Germany
Tel: +49-211-65030, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.
7th Floor, Quantum Plaza, No.27 ZhiChunLu Haidian District, Beijing 100083, P.R.China
Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.
Unit 301, Tower A, Central Towers, 555 LanGao Rd., Putuo District, Shanghai, China
Tel: +86-21-2226-0888, Fax: +86-21-2226-0999

Renesas Electronics Hong Kong Limited
Unit 1601-1613, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2886-9318, Fax: +852 2886-9022/9044

Renesas Electronics Taiwan Co., Ltd.
13F, No. 363, Fu Shing North Road, Taipei, Taiwan
Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd.
80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre Singapore 339949
Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd.
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia
Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

Renesas Electronics Korea Co., Ltd.
12F., 234 Teheran-ro, Gangnam-Gu, Seoul, 135-080, Korea
Tel: +82-2-558-3737, Fax: +82-2-558-5141

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